ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mf	g Infori	mation			
Supplier Inform	nation															
Company name*	Company unique ID			Unique ID Authority					Response Date*							
onsemi												2023-06-08				
Contact Name		Title - Contact]	Phone - Contact*					Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
Authorized Repres	entative*	Title - Representative			Phone - Representative*				Email - Representative*							
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Request	r Item Number Mfr Item Num NCT80DBR2		em Number Mfr Item Name				Effective Da	te Ve	Version M		Manufacturing Site		/eight*	k	UOM	Unit Type
			DBR2G	G Hardware Monitor with I2C serial interface		interface	2023-06-08	2023-06-08			122.86			mg	Each	
Janufacturing	Process Information	on														
Terminal	al Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 MSL	020 MSL Rating		Peak Process Body Temperate		ure Max Time at Peak		Temperatu	Temperature Number of Reflow Cyc		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 3		3		260		С	30		secono	ls 3			
Comments																
TTENTION: MS	L 3 Rated item requires I	Bake and D	ry Pack (after	r electrical test)												
or more informat	on regarding material co	mposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itaability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.34	mg	Supplier	Silicon (Si)	7440-21-3		1.34	mg
Die Attach	0.23		Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.046	mg
			Supplier	Silver (Ag)	7440-22-4		0.184	mg
Lead Frame	46.68		Supplier	Zinc (Zn)	7440-66-6		0.0467	mg
			Supplier	Iron (Fe)	7439-89-6		1.0736	mg
			Supplier	Copper (Cu)	7440-50-8		45.513	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0467	mg
Mold Compound-Black	73.13	mg		Epoxy Phenol Resin	proprietary data		7.6786	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		65.4513	mg
Plating	1.41	mg	Supplier	Palladium (Pd)	7440-05-3		0.0705	mg
			В	Nickel (Ni)	7440-02-0		1.269	mg
			Supplier	Gold (Au)	7440-57-5		0.0705	mg
Wire Bond - Cu	0.07	mg	Supplier	Copper (Cu)	7440-50-8		0.07	mg